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NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a “DS” number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is “DSXXXXXA”, where “XXXXX” is the document number and “A” is the revision level of the document.

INTRODUCTION

This chapter contains general information that will be useful to know before using the MCP355X Tiny Application Sensor Demo Board. Items discussed in this chapter include:

• Document Layout
• Conventions Used in this Guide
• Recommended Reading
• The Microchip Web Site
• Customer Support
• Document Revision History

DOCUMENT LAYOUT

This document describes how to use the MCP355X Tiny Application Sensor Demo Board as a development tool to emulate and debug firmware on a target board. The manual layout is as follows:

• Chapter 1. “Product Overview” – This is an introduction to the MCP355X Tiny Application Sensor Demo Board. It covers the kit contents, associated tools and how they work together.
• Chapter 2. “Installation and Operation” – Covers the initial set-up of the MCP355X Tiny Application Sensor Demo Board. It lists the required tools, shows how to connect this board and demonstrates how to verify the set-up.
• Appendix A. “Schematic and Layouts” – Gives detailed information on the MCP355X Tiny Application Sensor Demo Board. Includes detailed circuit explanation, schematic, board layouts and Bill of Materials (BOM).
• Appendix B. “Bill Of Materials (BOM)” – Gives detailed information on the MCP355X Tiny Application Sensor Demo Board’s firmware.
CONVENTIONS USED IN THIS GUIDE

This manual uses the following documentation conventions:

### DOCUMENTATION CONVENTIONS

<table>
<thead>
<tr>
<th>Description</th>
<th>Represents</th>
<th>Examples</th>
</tr>
</thead>
<tbody>
<tr>
<td>Arial font:</td>
<td>Referenced books</td>
<td><em>MPLAB® IDE User's Guide</em></td>
</tr>
<tr>
<td>Initial caps</td>
<td>A window</td>
<td>the Output window</td>
</tr>
<tr>
<td></td>
<td>A dialog</td>
<td>the Settings dialog</td>
</tr>
<tr>
<td></td>
<td>A menu selection</td>
<td>select Enable Programmer</td>
</tr>
<tr>
<td>Quotes</td>
<td>A field name in a window or dialog</td>
<td>“Save project before build”</td>
</tr>
<tr>
<td>Underlined, italic text with right angle bracket</td>
<td>A menu path</td>
<td>*File&gt;*Save</td>
</tr>
<tr>
<td>Bold characters</td>
<td>A dialog button</td>
<td>Click <em>OK</em></td>
</tr>
<tr>
<td></td>
<td>A tab</td>
<td>Click the <strong>Power</strong> tab</td>
</tr>
<tr>
<td>N'Rnnnn</td>
<td>A number in verilog format, where N is the total number of digits, R is the radix and n is a digit.</td>
<td>4'b0010, 2'hF1</td>
</tr>
<tr>
<td>Text in angle brackets &lt; &gt;</td>
<td>A key on the keyboard</td>
<td>Press <em>&lt;Enter&gt;, &lt;F1&gt;</em></td>
</tr>
</tbody>
</table>

**Courier New font:**

<table>
<thead>
<tr>
<th>Description</th>
<th>Represents</th>
<th>Examples</th>
</tr>
</thead>
<tbody>
<tr>
<td>Plain Courier New</td>
<td>Sample source code</td>
<td>#define START</td>
</tr>
<tr>
<td></td>
<td>Filenames</td>
<td>autoexec.bat</td>
</tr>
<tr>
<td></td>
<td>File paths</td>
<td>c:\mcc18\h</td>
</tr>
<tr>
<td></td>
<td>Keywords</td>
<td>_asm, _endasm, static</td>
</tr>
<tr>
<td></td>
<td>Command-line options</td>
<td>-Opa+, -Opa-</td>
</tr>
<tr>
<td></td>
<td>Bit values</td>
<td>0, 1</td>
</tr>
<tr>
<td></td>
<td>Constants</td>
<td>0xFF, ‘A’</td>
</tr>
<tr>
<td>Italic Courier New</td>
<td>A variable argument</td>
<td>file.o, where file can be any valid filename</td>
</tr>
<tr>
<td>Square brackets [ ]</td>
<td>Optional arguments</td>
<td>mcc18 [options] file [options]</td>
</tr>
<tr>
<td>Curly brackets and pipe character: {</td>
<td>Choice of mutually exclusive arguments; an OR selection</td>
<td>errorlevel {0</td>
</tr>
<tr>
<td>Ellipses...</td>
<td>Replaces repeated text</td>
<td>var_name [, var_name...]</td>
</tr>
<tr>
<td></td>
<td>Represents code supplied by user</td>
<td>void main (void) { ... }</td>
</tr>
</tbody>
</table>

**RECOMMENDED READING**

This user’s guide describes how to use the MCP355X Tiny Application Sensor Demo Board. Other useful documents are listed below. The following Microchip documents are available and recommended as supplemental reference resources.

**MCP3550/1/3 Data Sheet, “Low-Power Single Channel 22-Bit Delta-Sigma ADCs” (DS21950)**

This data sheet provides detailed information regarding the MCP355X product family.
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• **General Technical Support** – Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listing

• **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

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• Technical Support
• Development Systems Information Line

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Technical support is available through the web site at: http://support.microchip.com

DOCUMENT REVISION HISTORY

Revision A (April 2006)

• Initial Release of this Document.
Chapter 1. Product Overview

1.1 INTRODUCTION

This chapter provides an overview of the MCP355X Tiny Application Sensor Demo Board and covers the following topics:

• What is the MCP355X Tiny Application Sensor Demo Board?
• What the MCP355X Tiny Application Sensor Demo Board kit includes

1.2 WHAT IS THE MCP355X TINY APPLICATION SENSOR DEMO BOARD?

The MCP3550/1/3 devices are 2.7V to 5.5V low-power, 22-bit Delta-Sigma Analog-to-Digital Converters (ADCs). The MCP355X Tiny Application Sensor Demo Board is used to demonstrate the most basic application of the devices using a ratiometric connection with \( V_{DD} \) as \( V_{REF} \). The MCP355X Tiny Application Sensor Demo Board includes all the necessary PCB circuits and PCB layout tips required to obtain the performance demonstrated on the PC.

1.3 WHAT THE MCP355X TINY APPLICATION SENSOR DEMO BOARD KIT INCLUDES

This MCP355X Tiny Application Sensor Demo Board Kit includes:

• The MCP355X Tiny Application Sensor Demo Board (with MCP3551 installed)
• MCP355X Tiny Application Sensor Demo Board User’s Guide
• MCP3550/1/3 Data Sheet, “Low-Power Single Channel 22-Bit Delta-Sigma ADCs”, (DS21950)
• AN1007 Application Note “Designing with the MCP3551 Delta-Sigma ADC”, (DS01007)
• Mini-USB Cable
Chapter 2. Installation and Operation

2.1 INTRODUCTION

The MCP355X Tiny Application Sensor Demo Board is designed to demonstrate the performance of the MCP3550/1/3 devices in a simple low-cost application. The circuit uses a ratiometric sensor configuration and uses the system power supply as the voltage reference. The extreme common mode rejection capability of the MCP3551 device, along with its excellent normal mode power supply rejection at 50 and 60 Hz, allows for this system performance. The functional circuit block diagram is shown in Figure 2-1.

![Circuit Diagram](image)

**FIGURE 2-1:** Ratiometric Sensor Configuration.

2.2 FEATURES

The MCP355X Tiny Application Sensor Demo Board has the following features:

- Better than 16-bit system performance from a direct connected PC USB connection using ratiometric
- Simple USB connection to DataView on the PC showing system performance
- Low-cost design for analog-to-digital conversion
2.3 FUNCTIONAL BLOCK DESCRIPTIONS

2.3.1 SM5420

The SM5420 device is an absolute pressure sensor in a surface mount SOIC package. The device is a piezo resistive silicon device available from Silicon Microstructure. With a constant excitation voltage, the output changes linearly with pressure. The zero scale error of the device is rated at ±10 mV/V and the full scale output is rated at 60 mV/V ±20 mV. These large errors require an overall system calibration, as well as temperature compensation for a working absolute pressure sensor design. This board demonstrates the overall system resolution and noise performance of the ADC and sensor with no voltage reference.

2.3.2 MCP3551

The MCP3551 is a 22-bit Delta-Sigma A/D converter. The device includes a third-order modulator, fourth-order digital SINC filter, internal oscillator for oversampling clock and digital logic for a simple SPI interface.

Digital SINC Filter

The MCP3551 device includes a digital decimation filter, which is a fourth-order modified SINC filter. This filter averages the incoming bitstream from the modulator and outputs a 22-bit conversion word in binary two's complement. When all bits have been processed by the filter, the output code is ready for SPI communication, the RDY flag is set on the SDO/RDY pin and all the internal registers are reset in order to process the next conversion. This filter achieves greater than -80 dB of rejection at both 50 and 60 Hz. For improved performance, the MCP3550 device is available which gives greater than -120 dB of rejection at either 50 or 60 Hz.
2.3.3 PIC18F4550

The high speed USB PICmicro® microcontroller is used to connect to the PC and quickly evaluate system performance. An In-Circuit Serial Programming™ (ICSP™) connector is also included.

2.3.4 Filtering

Power supply filtering using passive components is included to improve the noise performance of the MCP3551 device. The following circuit comprises the filtering on the power supply, separating the analog and digital sections of the board:

2.3.5 DataView Noise Analysis

The system noise from the MCP355X Tiny Application Sensor Demo Board will be an aperiodic signal not having any wave or shape. This randomness is best dealt with in statistical properties, hence the RMS measurement of the Gaussian or normal distribution. When designing a system and attempting to measure the performance, the RMS noise is much more repeatable than the peak-to-peak noise. Figure 2-4 shows two different distributions with different RMS and PEAK values, representing two different ADC output distributions.
FIGURE 2-4: Two Normal or Gaussian Output Distributions.

The DataView software tool is a visualization tool, showing real-time histograms using the MCP3551. The software also calculates the RMS noise of the current distribution. The number of samples in the distribution is also scalable, allowing post averaging experiments.

FIGURE 2-5: DataView showing system performance in a histogram format.

The software can also be used for time-based system analysis using the scope plot window. Any system drift or other time-based errors can be analyzed using this visual analysis tool.

FIGURE 2-6: DataView Scope Plot View.
Appendix A. Schematic and Layouts

A.1 INTRODUCTION

This appendix contains the following schematics and layouts for the MCP355X Tiny Application Sensor Demo Board User’s Guide:

- Board Schematic
- Board - Top Layer
- Board - Bottom Layer

A.2 SCHEMATICS AND PCB LAYOUT

Figure A.3 “Board - Schematic” shows the MCP355X Tiny Application Sensor Demo Board schematic, while Figure A.4 “Board Layout - Top Layer” and Figure A.5 “Board Layout - Bottom Layer” show the layout for the two different layers. The layer order is shown in Figure A-1.

FIGURE A-1: LAYER ORDER

```
Top Layer

Bottom Layer
```
A.3 BOARD - SCHEMATIC
## Appendix B. Bill Of Materials (BOM)

### TABLE B-1: BILL OF MATERIALS (BOM)

<table>
<thead>
<tr>
<th>Qty</th>
<th>Reference</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>C1</td>
<td>CAP .47UF 16V CERAMIC X7R 0805</td>
<td>Panasonic® - ECG</td>
<td>ECJ-2YB1C474K</td>
</tr>
<tr>
<td>1</td>
<td>C2</td>
<td>CAP 1.0UF 10V CERAMIC X7R 0805</td>
<td>Kemet® Electronics</td>
<td>C0805C105K8RACTU</td>
</tr>
<tr>
<td>3</td>
<td>C3, C9, C10</td>
<td>CAP .1UF 25V CERAMIC X7R 0805</td>
<td>Panasonic - ECG</td>
<td>ECJ-2VB1E104K</td>
</tr>
<tr>
<td>2</td>
<td>C4, C6</td>
<td>CAP 22PF 50V CERM CHIP 0805 SMD</td>
<td>Panasonic - ECG</td>
<td>ECJ-2VC1H220J</td>
</tr>
<tr>
<td>1</td>
<td>C5</td>
<td>CAP .1UF 25V CERAMIC X7R 0805</td>
<td>Panasonic - ECG</td>
<td>ECJ-2VB1E104K</td>
</tr>
<tr>
<td>2</td>
<td>C7, C8</td>
<td>10uF/16V CAP-SMT-ELCTRO</td>
<td>Panasonic - ECG</td>
<td>EEE-1CA100SR</td>
</tr>
<tr>
<td>1</td>
<td>D1</td>
<td>LED RED CLEAR 0805 SMD</td>
<td>Lite-On Trading USA Inc</td>
<td>LTST-C170CKT</td>
</tr>
<tr>
<td>1</td>
<td>J1</td>
<td>CONN RECEPT MINI USB2.0 5POS</td>
<td>Hirose Electronic Co. Ltd</td>
<td>UX60-MB-5ST</td>
</tr>
<tr>
<td>1</td>
<td>J2</td>
<td>HEADER,.1&quot;ST MALE,1RW,6PIN,(10) .025&quot;PST,.23GOLDTAIL</td>
<td>Value-Pro</td>
<td>JS1109-6-R</td>
</tr>
<tr>
<td>1</td>
<td>JMP1</td>
<td>3PIN,.100&quot; Straight Male Headers (Gold)</td>
<td>Value-Pro</td>
<td>7000-1X3SG-R</td>
</tr>
<tr>
<td>1</td>
<td>JMP1</td>
<td>SHUNT LP W/HANDLE 2 POS 30AU</td>
<td>AMP®/Tyco® Electronics</td>
<td>881545-2</td>
</tr>
<tr>
<td>2</td>
<td>JP1, JP2</td>
<td>NOT INSTALLED</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>2</td>
<td>L1, L2</td>
<td>FERRITE 500MA 600 OHM 0805 SMD</td>
<td>Steward® Inc.</td>
<td>HZ0805E601R-10</td>
</tr>
<tr>
<td>1</td>
<td>PCB</td>
<td>RoHS Compliant Bare PCB, MCP355X Tiny Application Sensor Demo Board.</td>
<td>-</td>
<td>104-00093</td>
</tr>
<tr>
<td>2</td>
<td>R1, R2</td>
<td>NOT INSTALLED</td>
<td>Open</td>
<td>RES0805</td>
</tr>
<tr>
<td>1</td>
<td>R3</td>
<td>RES 1.00K OHM 1/10W 1% 0805 SMD</td>
<td>Panasonic - ECG</td>
<td>ERJ-6ENF1001V</td>
</tr>
<tr>
<td>1</td>
<td>R4</td>
<td>RES 100 OHM 1/10W 1% 0805 SMD</td>
<td>Panasonic - ECG</td>
<td>ERJ-6ENF1000V</td>
</tr>
<tr>
<td>1</td>
<td>U1</td>
<td>LM4140 IC VOLT REF PREC MICROPWR 8-SOIC</td>
<td>National Semiconductor®</td>
<td>LM4140CCM-4.1/NOPB</td>
</tr>
<tr>
<td>1</td>
<td>U2</td>
<td>PIC18F4550</td>
<td>Microchip Technology</td>
<td>PIC18F4550-I/PT</td>
</tr>
<tr>
<td>1</td>
<td>U3</td>
<td>SM5420 is an SO-8 packaged 15 PSI pressure sensor.</td>
<td>Silicon Microstructures, Inc.</td>
<td>SM5420-015-A-H-T</td>
</tr>
<tr>
<td>1</td>
<td>U4</td>
<td>MCP3551_MSOP</td>
<td>Microchip Technology</td>
<td>MCP3551-E/MS</td>
</tr>
<tr>
<td>1</td>
<td>Y1</td>
<td>CRYSTAL 20MHZ METAL CASE SMD</td>
<td>Connor-Winfield</td>
<td>XM-1-20.0000</td>
</tr>
<tr>
<td>2</td>
<td>Z1, Z2</td>
<td>RES 10.0K OHM 1/10W 1% 0805 SMD</td>
<td>Panasonic - ECG</td>
<td>ERJ-6ENF1002V</td>
</tr>
<tr>
<td>1</td>
<td>Z3</td>
<td>RES 0.0 OHM 1/8W 5% 0805 SMD</td>
<td>Panasonic - ECG</td>
<td>ERJ-6GEY0R00V</td>
</tr>
<tr>
<td>3</td>
<td>Z4, Z6, Z7</td>
<td>NOT INSTALLED</td>
<td>Open</td>
<td>RES0805_MCHIP</td>
</tr>
</tbody>
</table>
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Fax:  86-755-8203-1760

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